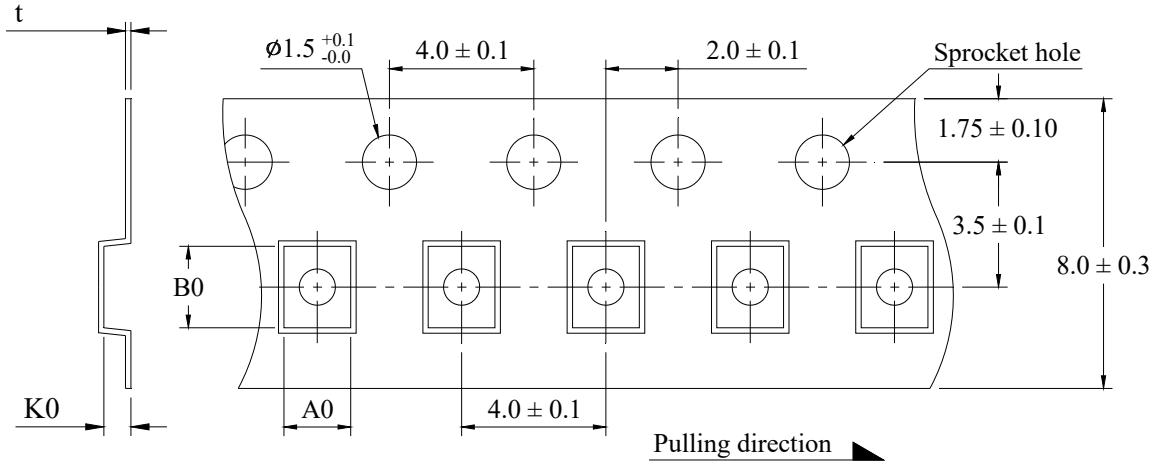


■ Packaging

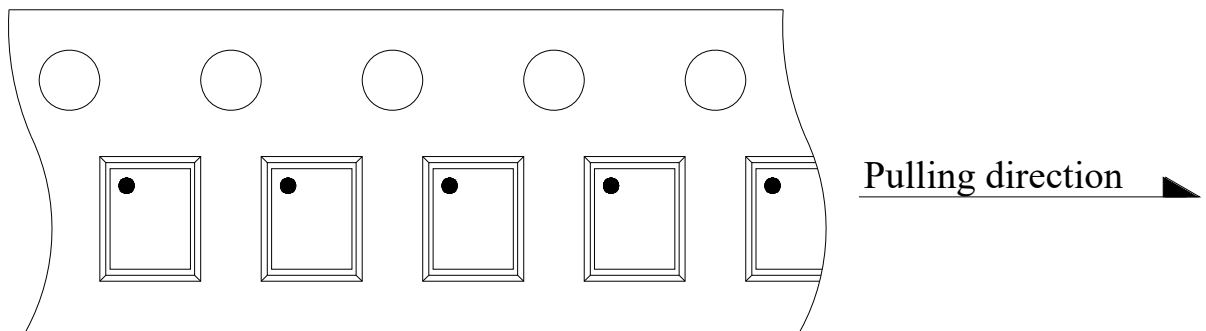
(1) Tape packaging dimensions



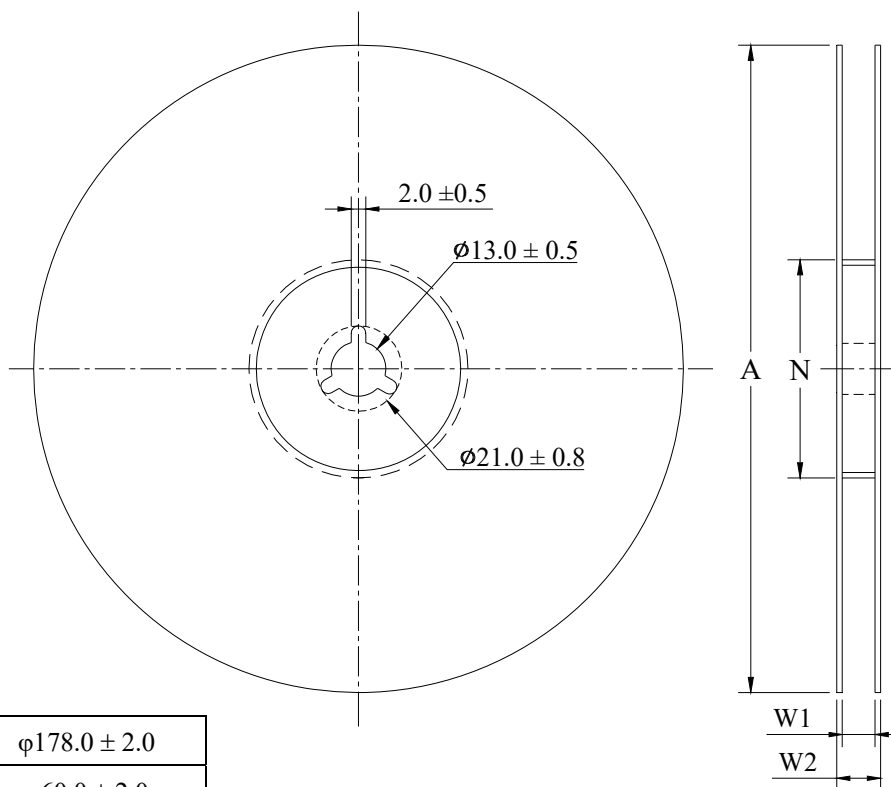
Dimensions Code (mm)				UNITS/REEL
A0	B0	K0	t	
2.9 ± 0.1	3.5 ± 0.1	1.35 ± 0.10	0.25 ± 0.05	2,000

(2) Tape Direction

The direction shall be seen from the top cover tape side.



(3) Reel dimensions



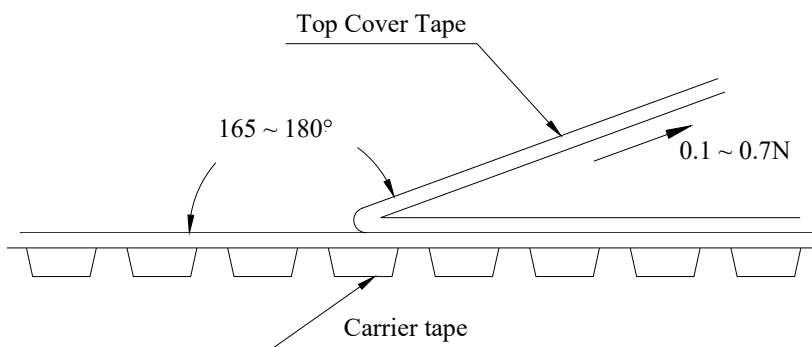
A	$\phi 178.0 \pm 2.0$
N	$\phi 60.0 \pm 2.0$
W1	9.0 ± 0.3
W2	11.4 ± 1.0

Unit : mm

(4) Peel force of top cover tape

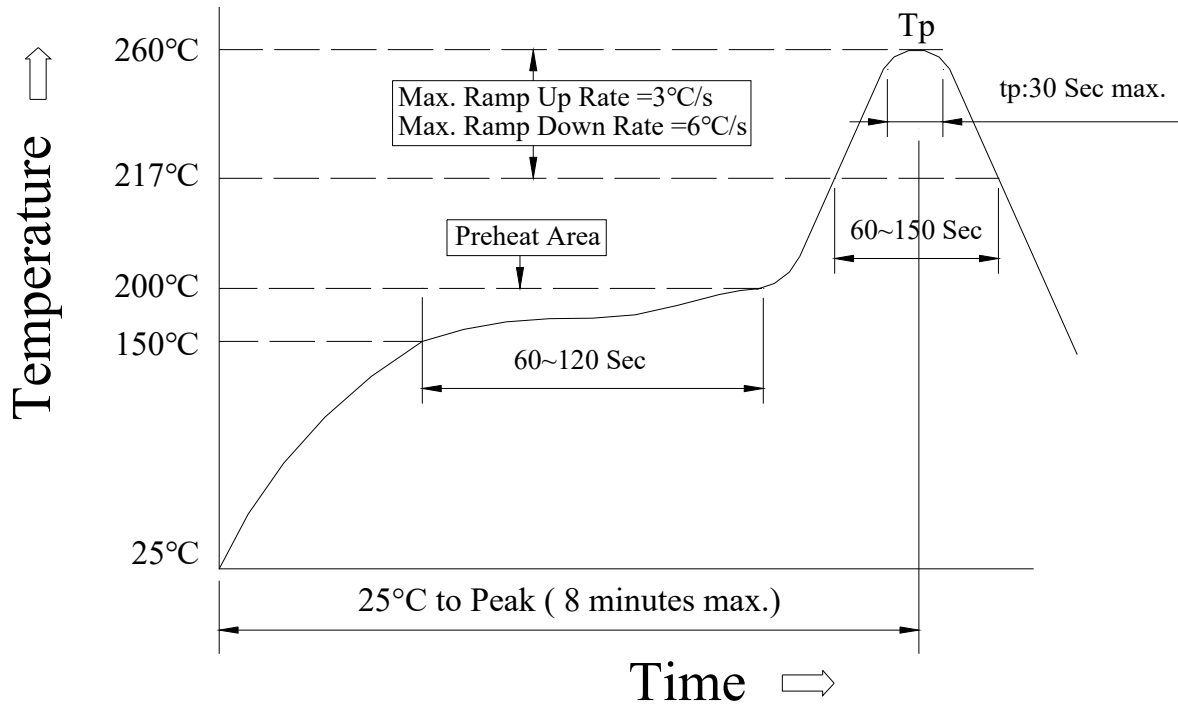
The peel speed shall be about 300 mm/minute.

The peel force of top cover tape shall be between 0.1 to 0.7N.



■ Reflow Profile

Power Choke Coil Type



(1) Reflow Soldering Method :

Reflow Soldering	Tp:255~260°C	Max.30 seconds (tp)
	217°C	60~150 seconds
Pre-Heat	150 ~ 200°C	60~120 seconds
Time 25°C to peak temperature	8 minutes max.	

(2) Soldering iron Method : 350 ± 5°C max.3 seconds